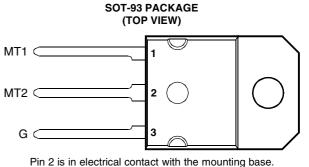
BOURNS®

- High Current Triacs
- 20 A RMS
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- 150 A Peak Current
- Max I_{GT} of 50 mA (Quadrants 1 3)



MDC2ADA

absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING			VALUE	UNIT	
	TIC253D		400		
Repetitive peak off-state voltage (see Note 1)	TIC253M	Ň	600	V	
	TIC253S	V _{DRM}	700		
	TIC253N		800		
Full-cycle RMS on-state current at (or below) 70°C case temperature (see Note 2)			20	Α	
Peak on-state surge current full-sine-wave at (or below) 25°C case temperature (see Note 3)			150	A	
Peak gate current			±1	A	
Operating case temperature range			-40 to +110	°C	
Storage temperature range			-40 to +125	°C	
Lead temperature 1.6 mm from case for 10 seconds			230	°C	

NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.

 This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 500 mA/°C.

3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of peak reverse volta ge and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium.

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	ТҮР	MAX	UNIT
I _{DRM}	Repetitive peak off-state current	V _D = Rated V _{DRM}	$I_{G} = 0$	T _C = 110°C			±2	mA
I _{GT}		V _{supply} = +12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		15	50	mA
	Gate trigger	$V_{supply} = +12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		-30	-50	
	current	V _{supply} = -12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		-20	-50	
		$V_{supply} = -12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		32		
V _{GT}		V _{supply} = +12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		0.8	2	v
	Gate trigger	$V_{supply} = +12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		-0.8	-2	
	voltage	$V_{supply} = -12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		-0.8	-2	
		$V_{supply} = -12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		0.8	2	
V _T	On-state voltage	I _T = ±28.2 A	l _G = 50 mA	(see Note 4)		±1.4	±1.7	V

† All voltages are with respect to Main Terminal 1.

NOTE 4: This parameter must be measured using pulse techniques, $t_p = \le 1$ ms, duty cycle ≤ 2 %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

PRODUCT INFORMATION

DECEMBER 1971 - REVISED SEPTEMBER 2002 Specifications are subject to change without notice.

electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS			MIN	ТҮР	MAX	UNIT	
I _Н	Holding current	V _{supply} = +12 V†	l _G = 0	Init' I _T = 100 mA		20	40	mA	
		V _{supply} = -12 V†	$I_{G} = 0$	Init' I _T = -100 mA		-10	-40	ША	
IL.	Latching current	V _{supply} = +12 V†	(see Note 5)			20		mA	
		V _{supply} = -12 V†	(366 1016 3)		-20		ША		
dv/dt	Critical rate of rise of	V _D = Rated V _D	I _G = 0	T _C = 110°C		±450		V/µs	
uv/ui	off-state voltage			1 _C = 110 0					
dv/dt _(c)	Critical rise of	V _D = Rated V _D		$T_{\rm C} = 80^{\circ}{\rm C}$		±1		V/µs	
	commutation voltage	$di/dt = 0.5 I_{T(RMS)}/ms$		$I_T = 1.4 I_{T(RMS)}$				v/µs	
di/dt	Critical rate of rise of	V _D = Rated V _D	I _{GT} = 50 mA	$L = 50 m \Lambda$ $T = 110^{\circ} C$	T _C = 110°C		±100		A/µs
ui/ut	on -state current	di _G /dt = 50 mA/µs		1 <u>C</u> = 110 C		100		πµs	

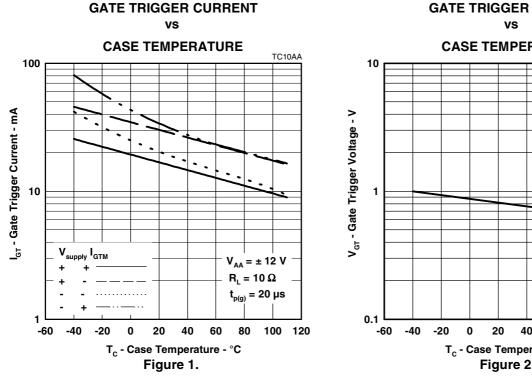
† All voltages are with respect to Main Terminal 1.

NOTE 5: The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics: $R_G = 100 \ \Omega$, $t_{p(g)} = 20 \ \mu$ s, $t_r = \le 15 \ n$ s, $f = 1 \ kHz$.

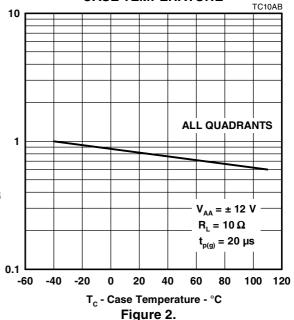
thermal characteristics

PARAMETER			TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.52	°C/W
R _{0JA}	Junction to free air thermal resistance			36	°C/W

TYPICAL CHARACTERISTICS



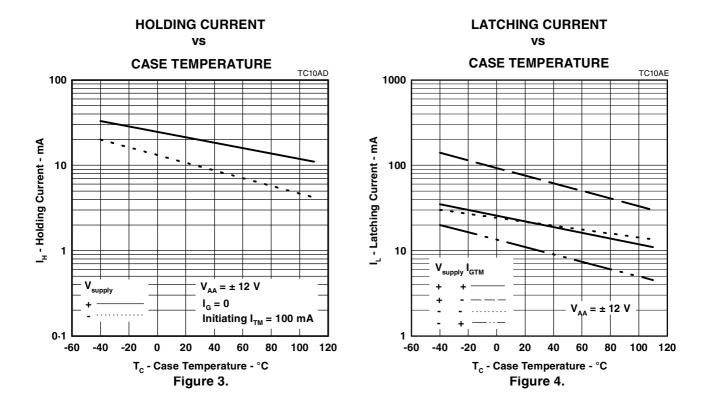
GATE TRIGGER VOLTAGE **CASE TEMPERATURE**



INFORMATION PRODUCT

> DECEMBER 1971 - REVISED SEPTEMBER 2002 Specifications are subject to change without notice.

TYPICAL CHARACTERISTICS



PRODUCT INFORMATION